

高速光耦

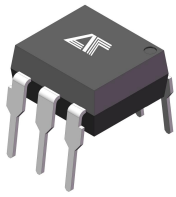
High speed optocoupler

H11LX

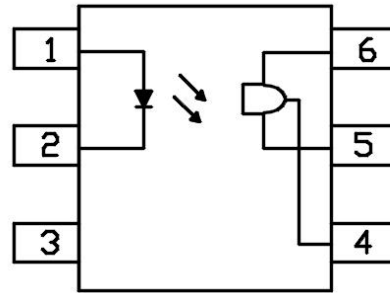
Product Data Sheet

AOTE DCC
RELEASE

DIP6



SMD6



Pin Configuration

- 1.Anode
- 2.Cathode
- 3.NC
- 4.VO
- 5.GND
- 6.VCC

封装逻辑原理图 Encapsulation logic schematic

H11LX 系列光耦采用高效光电转换技术，结合先进封装工艺，提供输入输出间的可靠隔离，支持DIP6、SMD6两种封装形式，适配多样化场景需求。

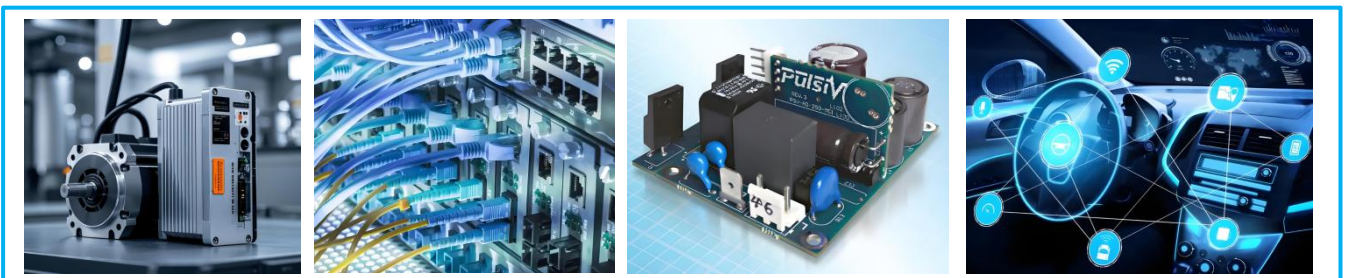
The H11LX series optocoupler adopts high-efficiency photoelectric conversion technology and advanced packaging processes, providing reliable input-output isolation. It supports two package types (DIP6, SMD6) to meet diverse application requirements.

产品特征Product features

- 输入-输出隔离电压 $V_{ios}=5000V_{rms}$
Input output isolation voltage: $V_{ios}=5000 V_{rms}$
- 高传输比特率: 2MBit/s; High transmission ratio 2MBit/s;
- 极短开启时间和关断时间 (4/4us) ; very short Turn on/off time(4/4us)
- 爬电距离>7.0mm ; Creepage distance > 7.0mm;
- 输入-输出绝缘距离 >0.4mm ; Input-Output insulation Thickness > 0.4mm
- 防潮等级 class1; MSL class1
- 产品符合 ROHS、REACH 及 HF 等环保法规要求;
The products comply with ROHS, REACH and HF;

应用领域 Applications

- 通信与网络Communications and Networking光纤通信, 数据中心Fiber optic communication, data center
- 工业自动化与控制 Industrial Automation and Control
PLC与变频器, 伺服驱动系统, 工业机器人 PLC and frequency converter, servo drive system, industrial robot
- 电机驱动与能源管理 Motor Drive and Energy Management; 电机控制, 电机保护, 电力电子, 消费电子
Motor control, motor protection, Power electronics, Consumer Electronics
- 新兴技术领域Emerging technology fields
智能交通系统, 医疗设备, 自动化生产线Intelligent Transportation System, medical equipment, Automatic production line



◆ 极限参数 Absolute Maximum Ratings (Ta =25°C)

参数 Parameter		符号 Symbol	额定值 Rating	单位 Unit
发射端 Input	正向电流 Forward Current	IF	60	mA
	反向电压 Reverse Voltage	VR	6	V
	功耗 Power Dissipation	PD	120	mW
接收端 Output	V45 允许范围 V45 Allowed Range	VO	0-16	V
	V65 允许范围 V65 Allowed Range	VCC	3-16	V
	输出电流 Output Current	IO	50	mA
	功耗 power dissipation	PD	150	mW
隔离电压 Isolation Voltage		Viso	5000	Vrms
工作温度 Operating Temperature		Topr	-55 ~ +110	°C
存储温度 Storage Temperature		Tstg	-55 ~ +125	°C
焊接温度 Soldering Temperature		Tsol	260	°C

◆ 推荐操作条件 Recommended Operating Conditions

参数 Parameter		符号 Symbd	最小值 Min	最大值 Max	单位 unit
开启阈值电流 Turn on Threshold Current	ATH11L1	IF (on)	1.6	15	mA
	ATH11L2		10	15	
	ATH11L3		5	15	
电源电压 Power Supply Voltage		VDD	3	15	V

◆ 产品特性参数Product characteristic parameters (Ta =25°C)

参数 Parameter		符号 Symbol	条件 Condition	最小 Min.	典型 Typ.	最大 Max.	单位 Unit
输入 Input	正向电压 Forward Voltage	VF	IF =10mA	-	1.24	1.5	V
	反向电流 Reverse Current	IR	VR =5V	-	-	10	uA
	输入电容 Input capacitance	CJ	V=0, f=1MHz	-	-	100	pF
输出 Output	电压运行范围 Operation Voltage Range	VCC	-	3	-	15	V
	电源电流 Supply Current	ICC (off)	IF =0mA, Vcc=5V	-	0.62	1.5	mA
	高输出电流 Output Current, High	IOH	IF =0mA, Vcc=Vo =15V	-	-	100	uA
	隔离电阻 Isolation Resistance	RISO	VI-O =500VDC	10 ¹¹	-	-	Ω
传输特性 Transfer Characteristics	电源电流 Supply Current	ICC (on)	IF =10mA, Vcc=5V	-	0.67	1.5	mA
	低输出电压 Output Voltage .low	VOL	Vcc=5V, IF =IFon(max.) RL=270Ω	-	-	0.4	V
	开启阈值电流 Turn onThreshold Current	ATH11L1	Vcc=5V, RL =270Ω	1.6	-	-	mA
		ATH11L2		10	-	-	
		ATH11L3		5	-	-	
	滞后比 Hysteresis Ratio	IFoff /IFon	Vcc=5V, RL =270Ω	0.5	-	0.9	-
	开启时间Turn on Time	ton	Vcc=5V, IF =IFon, RL =270Ω	-	-	4	μs
	下降时间Fall Time	tf		-	0.1	-	μs
	关闭时间Turn off Time	toff		-	-	4	μs
	上升时间Rise Time	tr		-	0.1	-	μs

◆ 电性特性曲线 Electrical characteristic curve ($T_A = 25^\circ\text{C}$)

Fig.1 Forward current vs Forward voltage

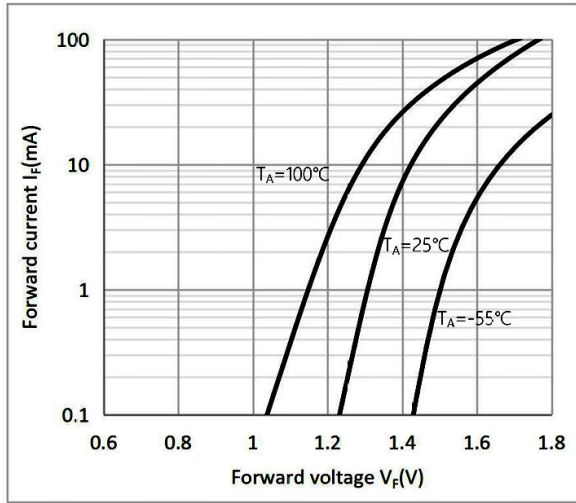


Fig.2 Output voltage vs Forward current

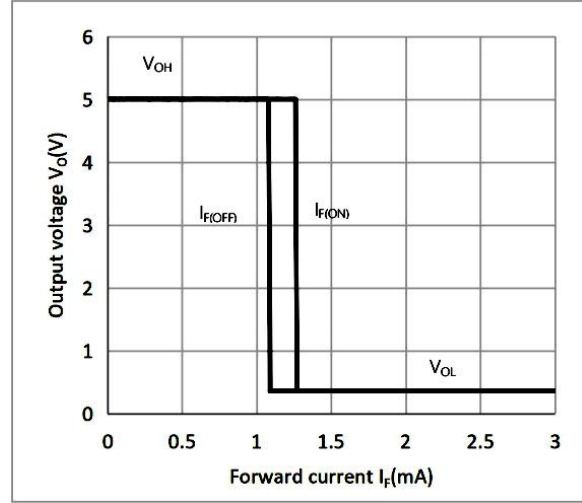


Fig.3 Input threshold current vs Supply voltage

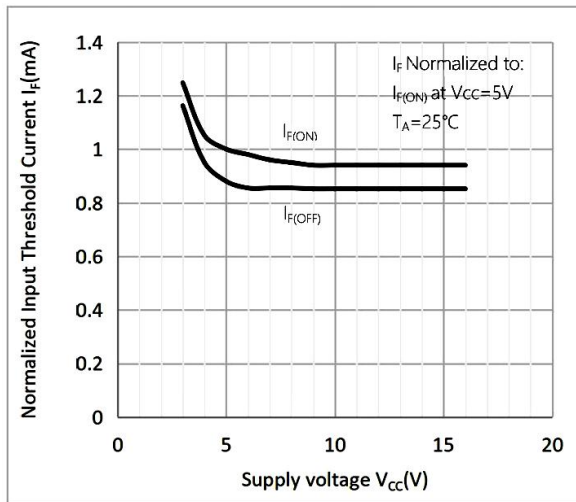


Fig.4 Input threshold current vs Ambient temperature

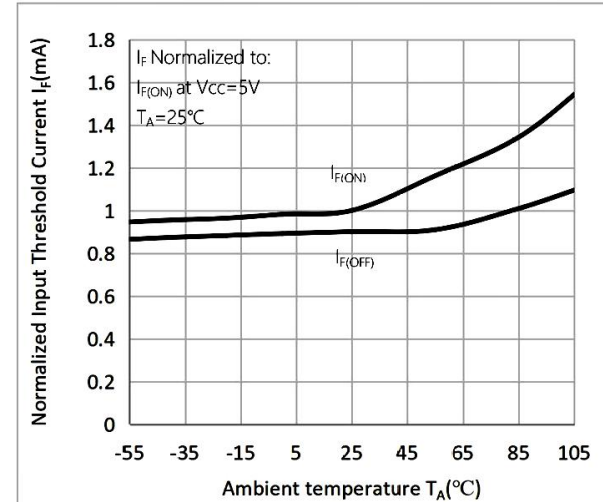


Fig.5 Low level output voltage vs Load current

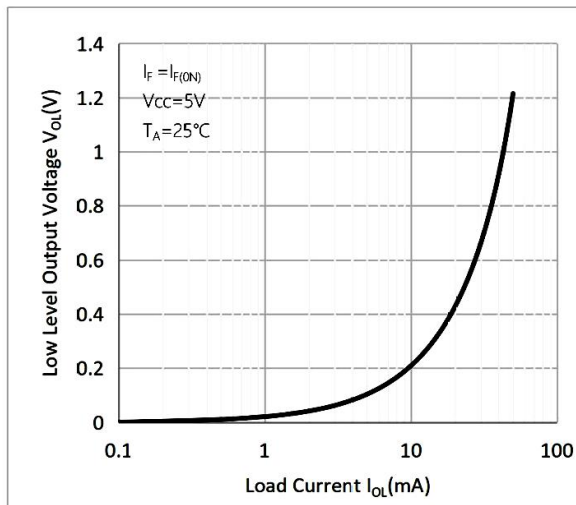
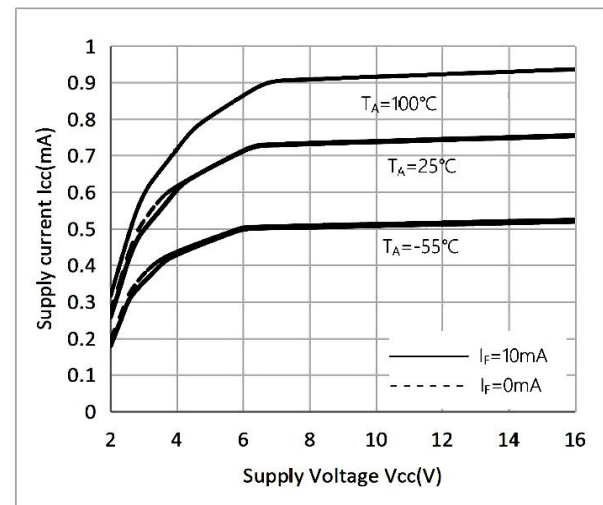
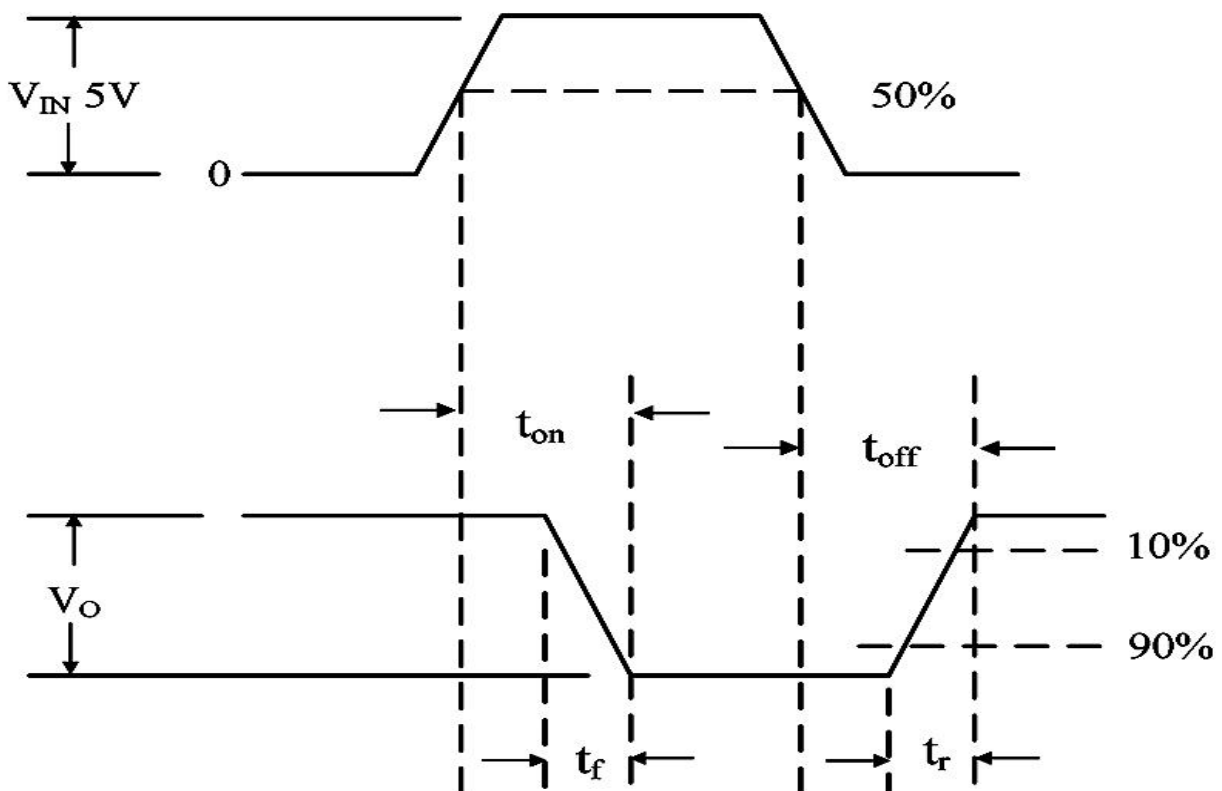
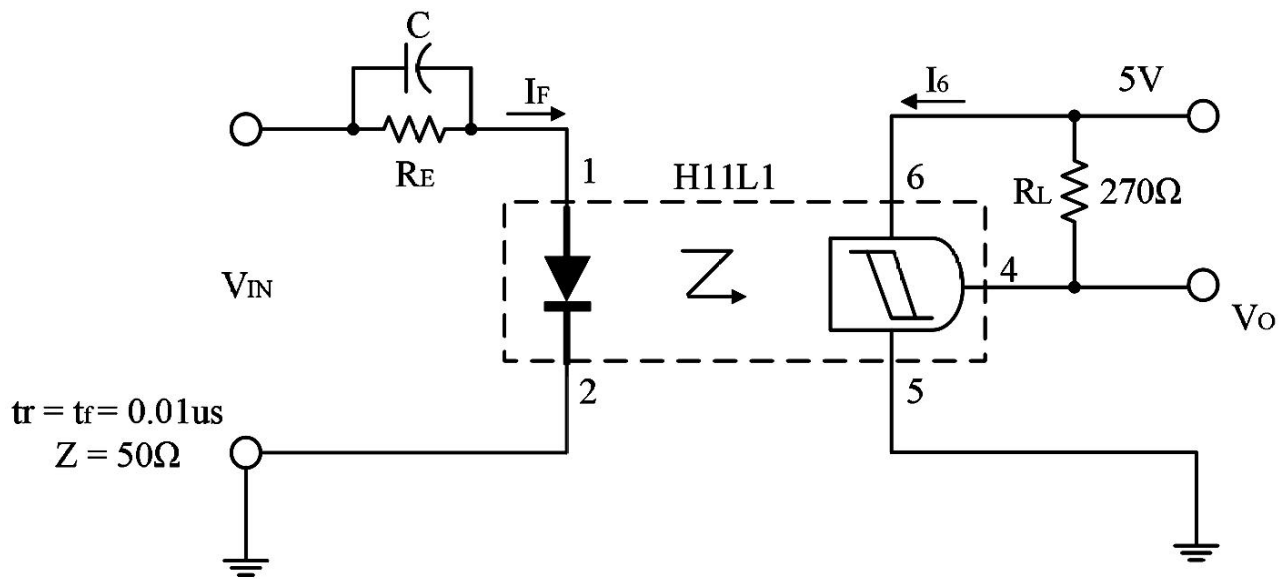


Fig.6 Supply current vs Supply voltage

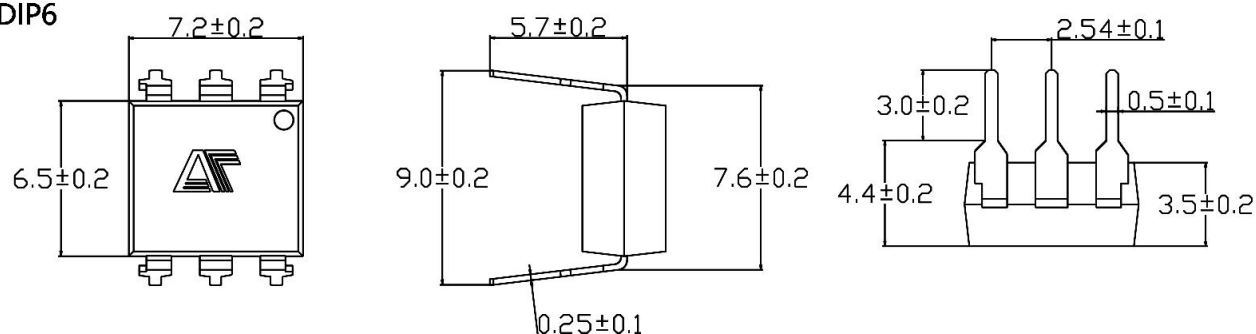


◆ 开关时间测试电路 Switching Time Test Circuit & Waveforms

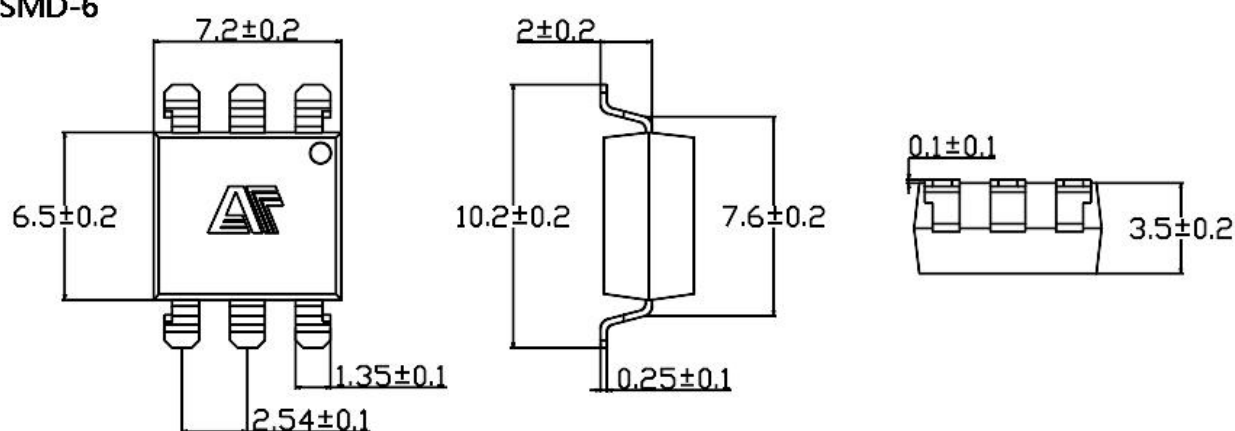


◆ 外形尺寸Overall dimension

DIP6

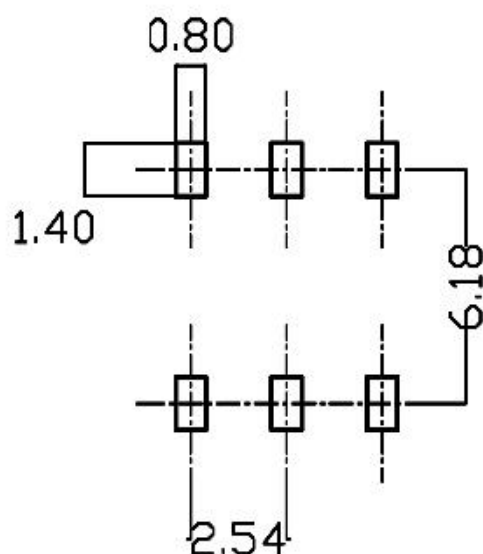


SMD-6



推荐焊盘:

Recommended



单位: mm

◆ 印字信息 Marking Information

- 印字中 “  ” 为奥特品牌LOGO
“  ” denotes LOGO
- 印字中的 “X” 代表产品：1、2、3 或空白
“X” denotes the classification: 1、2、3 or None
- 印字中 “Y” 代表年份； A(2018),B(2019),C(2020)
“Y” denotes YEAR: A(2018), B(2019), C(2020)
- 印字中 “WW” 代表周号
“WW” denotes Week' s number
- 印字中 “ E” 代表内部代码
“E” denotes Internal code
- 印字中的 “11” 代表工厂

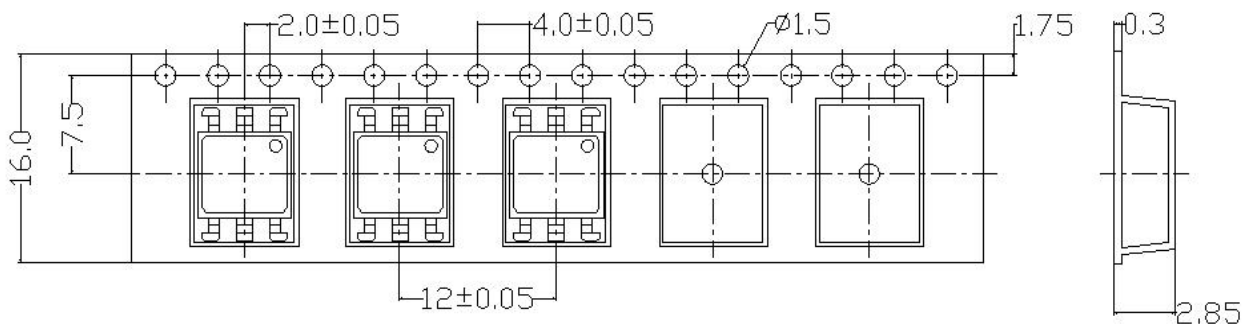
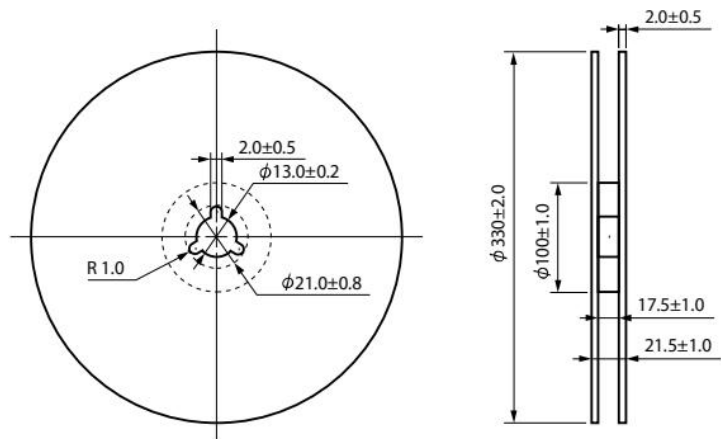


◆ 包装packing

封装形式	包装方式	盘数量	盒数量	箱数量	静电袋规格	盒规格	箱(双瓦楞)规格	备注
SMD6	卷盘 ($\phi 330\text{mm}$ 蓝盘)	1000 只/盘	2 盘/盒	10 盒/箱	450*390* 0.1mm	340*60* 340mm	620*360* 365mm	首尾端空至少 200mm
DIP6	管装 (500*12*11mm)	65 只/管	50 管/盒	10 盒/箱	不适用	525*128* 56mm	535*275* 300mm	每管使用蓝白胶 塞 , 方向须一致
Package Type	Packing Form	Quantity per Reel	Quantity per Box	Quantity per Carton	Antistatic Bag Specification	Box Specification	Carton Specification	Note
SMD6	Reel ($\phi 330\text{mm}$ Blue)	1000 pcs/reel	2 reels/box	10 boxes/ctn	450*390* 0.1mm	340*60* 340mm	620*360* 365mm	Guard band 200mm min.
DIP6	Tube (500*12*11mm)	65 pcs /tube	50 tubes/box	10 boxes/ctn	NA	525*128* 56mm	535*275* 300mm	Endplug (blue) and Endplug (white) keep the direction

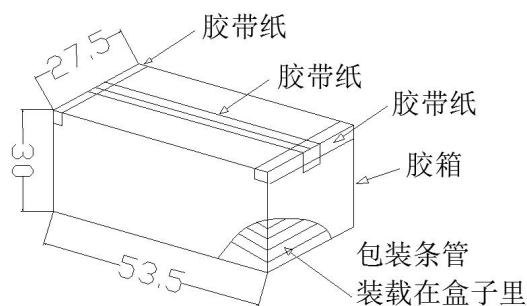
• 编带包装 Tape & Reel

- 1) 每卷数量: 1000 只;
Qty/reel: 1000 pcs.
- 2) 每箱数量: 20000 只;
Qty/ctn: 20000 pcs.
- 3) 内包装: 每盒 2 盘;
Inner packing: 2 reels/box.
- 4) 示意图 Schematic:



• 管条包装 Tape & Tube

- 1) 每管数量: 65 只;
Qty/Tube: 65 pcs.
- 2) 每箱数量: 32500 只;
Qty/ctn: 32500 pcs.
- 3) 内包装: 每盒 50 管;
Inner packing: 50 Tube/box.
- 4) 示意图 Schematic:

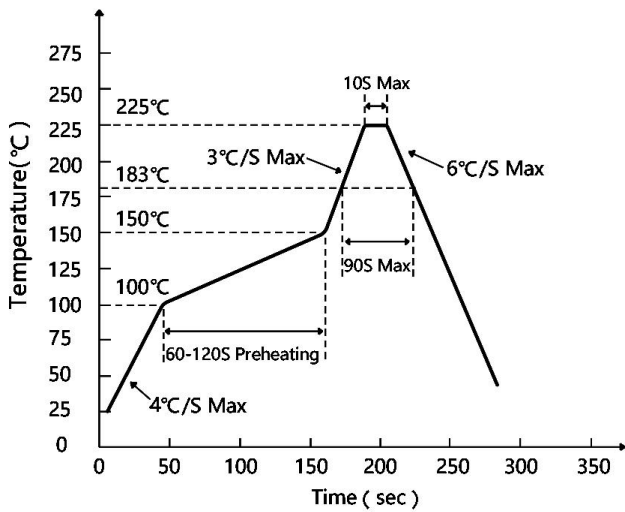


单位: mm

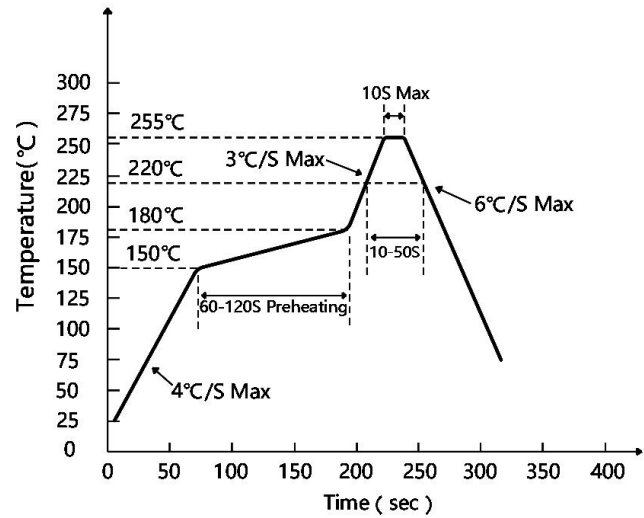
◆ 可靠性测试 Reliability Test Items And Conditions

实验项目 Test Items	参考标准 Reference	实验条件 Test Conditions	时间 Time	样品数 Quantity	判据 Criterion
可焊性 Solderability	JESD22-B102	Tsol= (245±5) °C, t=5s;	1 次1 times	22	0/22
耐焊接热 Resistance to Soldering Heat	JESD22-A106	Tsol= (260±5) °C, t=10s	3 次3 times	22	0/22
静电放电 ESD-HBM	JESD22-A114	Ta=25°C, HBM (2000V)	正反各 3 次 P&N 3 times	10	0/10
高温贮存 High emperature Storage	JESD22-A103	Ta=125°C	1000h	22	0/22
低温贮存 Low Temperature Storage	JESD22-A119	Ta= -55°C	1000h	22	0/22
冷热冲击 Thermal Shock	JESD22-A104	-55°C(15min)←→ 125°C(15min)	循环 300 次 300 cycles	22	0/22
常温寿命试验 Lifespan Test	JESD22-A108	Ta=25°C, IF=50mA , Vcc=5V	1000h	22	0/22
高温寿命试验 DC Operating Life	JESD22-A108	Ta=110°C, IF=20mA , Vcc=5V	1000h	76	0/76
高温高湿偏压 High Temperature High Humidity bias Voltage	JESD22-A101	Ta =85°C , RH=85% IF=0mA , VCE=64V	1000h	22	0/22
高温偏压 High Temperature bias Voltage	JESD22-A108	Ta =110°C , IF=0mA , VCE=80V	1000h	22	0/22
高压蒸汽试验 High pressure steam test	JESD22-A102	P=15PSIG , 121°C, 100%RH	96h	22	0/22

◆ 回流焊温度曲线图 Solder Reflow Profile

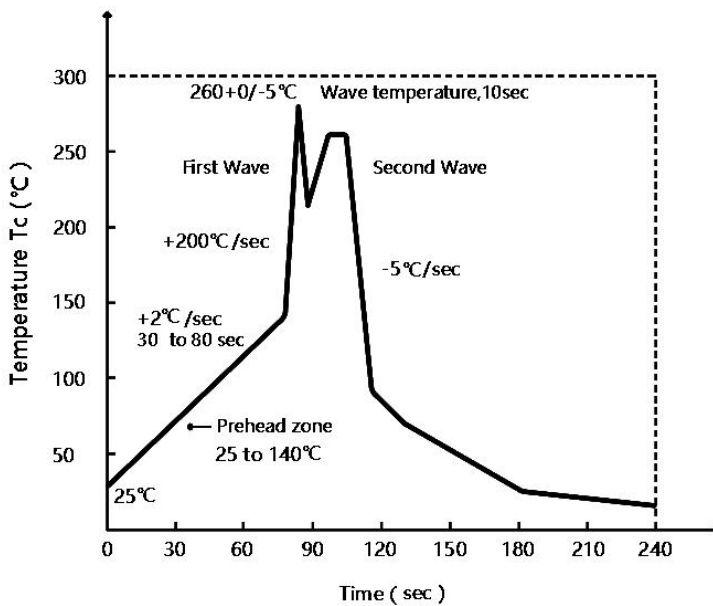


有铅制程 Lead Process



无铅制程 Lead Process

◆ 波峰焊温度曲线图 Wave Soldering Profile



◆ 手工烙铁焊接 Soldering with hand soldering iron

A. 手工烙铁焊仅用于产品返修或样品测试;

Hand soldering iron is only used for product rework or sample testing;

B. 手工烙铁焊要求: 温度 $350^{\circ}\text{C} \pm 5^{\circ}\text{C}$, 时间 $\leq 3\text{s}$.

Hand soldering iron requirements: Temperature: $350^{\circ}\text{C} \pm 5^{\circ}\text{C}$, within 3s.

◆ 注意 Attention

- 奥特半导体实施动态技术迭代机制，产品规格可能随工艺升级调整，最新技术参数以官网发布版本为准。

AOTE implements dynamic technical updates. Specifications are subject to change. Refer to the official website for the latest version.

- 用户需严格遵循本规格书限定的操作条件，因超范围使用（包括但不限于过载、高温、非兼容电路设计）导致的器件失效，不在质量保证范围内。

Users must strictly adhere to specified conditions. Failures caused by misuse (overload, high temperature, incompatible circuits) are excluded from warranty.

- 医疗设备、工业控制等关键场景应用前，需联系技术支持获取定制化验证方案。

Contact technical support for customized validation in critical applications (medical devices, industrial control).

- 本文档有效期至2025年12月31日，后续更新将通过官网公告推送。

This document is valid until Dec 31, 2025. Updates will be notified on the official website.

- 如需对技术参数或应用方案进行进一步确认，欢迎通过以下渠道获取官方支持：

For further clarification on technical specifications or application solutions, please contact us through official channels: